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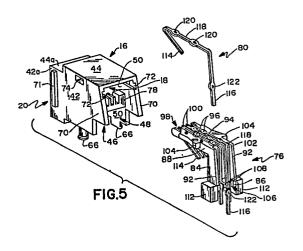
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(54) Modular electrical connector.

A low profile connector in the form of a right angle phone jack (10) for use with printed circuit boards is disclosed. The jack includes a dielectric housing member (16) having a modular plug receiving socket (18) formed therein, a forward mating end (20) and a rearward end. The socket (18) is defined by a plug-receiving opening (22) formed in the forward mating end with a lower latch receiving region (24) and extends rearwardly to meet a back surface provided in the housing member (16). The housing member (16) is mounted with its forward mating end (20) disposed beyond an edge (26) of the printed circuit board (12). The forward mating end (20) of the housing member (16) is offset downwardly so that the lower latch receiving region (24) of the plug receiving opening (22) is below the upper surface (28) of the circuit board (12). In addition, the housing member (16) co-operates with the printed circuit board surface to define the socket (18) whereby the upper surface (28) of the circuit board is the bottom surface of the socket (18). The low profile modular jack is for use with printed circuit boards arranged in modern closely-spaced mother-daughter arrangements.



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